# **NX3DV221**

# High-speed USB 2.0 switch with enable

Rev. 4 — 19 June 2013

**Product data sheet** 

# 1. General description

The NX3DV221 is a high-bandwidth switch designed for the switching of high-speed USB 2.0 signals in handset and consumer applications. These applications could be cell phones, digital cameras, and notebooks with hubs or controllers with limited USB I/Os. The wide bandwidth (1 GHz) of this switch allows signal to pass with minimum edge and phase distortion. The device multiplexes differential outputs from a USB host device to one of two corresponding outputs. The switch is bidirectional and offers little or no attenuation of the high-speed signals at the outputs. It is designed for low bit-to-bit skew and high channel-to-channel noise isolation, and is compatible with various standards, such as high-speed USB 2.0 (480 Mbps).

#### 2. Features and benefits

- Wide supply voltage range from 2.3 V to 3.6 V
- Switch voltage accepts signals up to 5.5 V
- 1.8 V control logic at V<sub>CC</sub> = 3.6 V
- Low-power mode when OE is HIGH (2 μA maximum)
- 6 Ω (maximum) ON resistance
- lacksquare 0.1  $\Omega$  (typical) ON resistance mismatch between channels
- 6 pF (typical) ON-state capacitance
- High bandwidth (1.0 GHz typical)
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 8000 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
  - ◆ HBM exceeds 12000 V for I/O to GND protection
- Specified from -40 °C to +85 °C

# 3. Applications

Routes signals for USB 1.0, 1.1 and 2.0



# High-speed USB 2.0 switch with enable

# 4. Ordering information

Table 1. Ordering information

| Type number | Package           | Package |   |           |  |  |  |  |  |  |
|-------------|-------------------|---------|---|-----------|--|--|--|--|--|--|
|             | Temperature range | Name    | Description   | Version   |  |  |  |  |  |  |
| NX3DV221GM  | –40 °C to +85 °C  | XQFN10  | plastic extremely thin quad flat package; no leads; 10 terminals; body 2 $\times$ 1.55 $\times$ 0.5 mm        | SOT1049-3 |  |  |  |  |  |  |
| NX3DV221TK  | –40 °C to +85 °C  | HVSON10 | plastic thermal enhanced very thin small outline package; no leads; 10 terminals; $3 \times 3 \times 0.85$ mm | SOT650-2  |  |  |  |  |  |  |

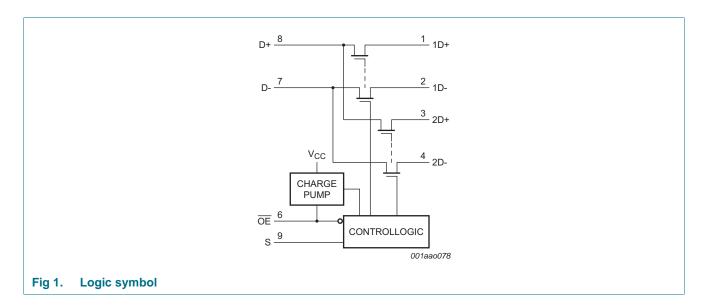
# 5. Marking

Table 2. Marking

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| NX3DV221GM  | x21                         |
| NX3DV221TK  | x21                         |

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

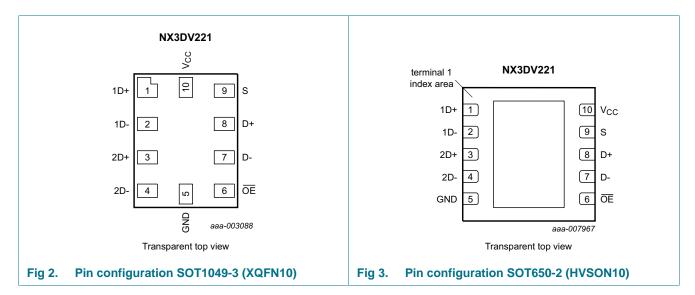
# 6. Functional diagram



High-speed USB 2.0 switch with enable

# 7. Pinning information

### 7.1 Pinning



# 7.2 Pin description

Table 3. Pin description

| Symbol          | Pin | Description                      |
|-----------------|-----|----------------------------------|
| 1D+             | 1   | independent input or output      |
| 1D-             | 2   | independent input or output      |
| 2D+             | 3   | independent input or output      |
| 2D-             | 4   | independent input or output      |
| GND             | 5   | ground (0 V)                     |
| ŌĒ              | 6   | output enable input (active LOW) |
| D-              | 7   | common input or output           |
| D+              | 8   | common input or output           |
| S               | 9   | select input                     |
| V <sub>CC</sub> | 10  | supply voltage                   |

# 8. Functional description

Table 4. Function table[1]

| Input |    | Channel            |
|-------|----|--------------------|
| S     | OE |                    |
| L     | L  | D+ = 1D+; D- = 1D- |
| Н     | L  | D+ = 2D+; D- = 2D- |
| X     | Н  | switches off       |

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care.

NX3DV221

### High-speed USB 2.0 switch with enable

# 9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions  | Min             | Max  | Unit |
|------------------|-------------------------|---|-----------------|------|------|
| $V_{CC}$         | supply voltage          |   | -0.5            | +4.6 | V    |
| VI               | input voltage           | S, OE input   | <u>[1]</u> –0.5 | +7.0 | V    |
| $V_{SW}$         | switch voltage          |   | <u>[2]</u> –0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | $V_{I} < -0.5 \text{ V}$                                    | -50             | -    | mA   |
| I <sub>SK</sub>  | switch clamping current | $V_{I} < -0.5 \text{ V}$                                    | -50             | -    | mA   |
| I <sub>SW</sub>  | switch current          |   | -               | ±120 | mA   |
| I <sub>CC</sub>  | supply current          |   | -               | +100 | mA   |
| $I_{GND}$        | ground current          |   | -100            | -    | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65             | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$ | -               | 250  | mW   |

<sup>[1]</sup> The minimum input voltage rating may be exceeded if the input current rating is observed.

# 10. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol           | Parameter           | Conditions  | Min | Max      | Unit |
|------------------|---------------------|-------------|-----|----------|------|
| $V_{CC}$         | supply voltage      |             | 2.3 | 3.6      | V    |
| VI               | input voltage       | S, OE input | 0   | $V_{CC}$ | V    |
| $V_{SW}$         | switch voltage      |             | 0   | 5.5      | V    |
| T <sub>amb</sub> | ambient temperature |             | -40 | +85      | °C   |

# 11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol   | Parameter                 | Conditions   | T <sub>amb</sub> = 25 °C |      |     | T <sub>amb</sub> =-40 ° | Unit         |    |
|----------|---------------------------|--|--------------------------|------|-----|-------------------------|--------------|----|
|          |                           |  | Min                      | Тур  | Max | Min                     | Max          |    |
| $V_{IH}$ | HIGH-level                | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | -                        | -    | -   | 0.46V <sub>CC</sub>     | -            | V  |
|          | input voltage             | $V_{CC}$ = 2.7 V to 3.6 V  | -                        | -    | -   | $0.46V_{CC}$            | -            | V  |
| $V_{IL}$ | V <sub>IL</sub> LOW-level | $V_{CC}$ = 2.3 V to 2.7 V  | -                        | -    | -   | -                       | $0.25V_{CC}$ | V  |
|          | input voltage             | $V_{CC}$ = 2.7 V to 3.6 V  | -                        | -    | -   | -                       | $0.25V_{CC}$ | V  |
| $V_{IK}$ | input clamping voltage    | $V_{CC} = 2.7 \text{ V}, 3.6 \text{ V};$<br>$I_I = -18 \text{ mA}$   | -                        | -    | -   | -                       | -1.8         | V  |
| Iı       | input leakage<br>current  | S, $\overline{OE}$ input;<br>$V_{CC} = 0 \text{ V}, 2.7 \text{ V}, 3.6;$<br>$V_{I} = \text{GND to } 3.6 \text{ V}$ | -                        | 0.01 | -   | -                       | ±1           | μΑ |

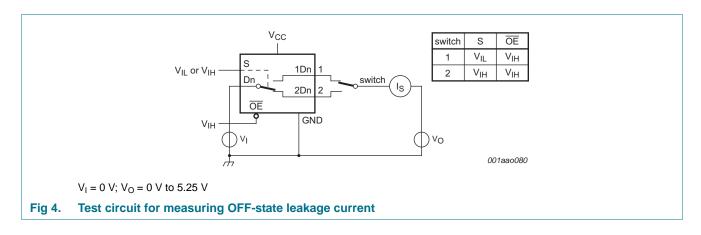
<sup>[2]</sup> The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

# High-speed USB 2.0 switch with enable

**Table 7. Static characteristics** ...continued
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol              | Parameter                 | Conditions  | Ta  | <sub>amb</sub> = 25 | °C  | T <sub>amb</sub> =-40 ° | °C to +85 °C | Unit |
|---------------------|---------------------------|---|-----|---------------------|-----|-------------------------|--------------|------|
|                     |                           |   | Min | Тур                 | Max | Min                     | Max          |      |
| I <sub>OFF</sub>    | power-off                 | per pin; V <sub>CC</sub> = 0 V  | '   | '                   |     | '                       | '            |      |
|                     | leakage current           | $V_{SW} = 0 V \text{ to } 2.7 V$  | -   | 0.01                | -   | -                       | ±2.0         | μΑ   |
|                     |                           | $V_{SW} = 0 \text{ V to } 3.6 \text{ V}$  | -   | 0.01                | -   | -                       | ±2.0         | μΑ   |
|                     |                           | $V_{SW} = 0 \text{ V to } 5.25 \text{ V}$   | -   | 0.01                | -   | -                       | ±3.0         | μΑ   |
| I <sub>S(OFF)</sub> | OFF-state leakage current | nD+ and nD- ports;<br>see Figure 4  |     |                     |     |                         |              |      |
|                     |                           | $V_{CC} = 2.7 \text{ V}, 3.6 \text{ V}$   | -   | -                   | -   | -                       | ±1           | μΑ   |
| I <sub>CC</sub>     | supply current            | $V_{CC} = 2.7 \text{ V}, 3.6 \text{ V}$   |     |                     |     |                         |              |      |
|                     |                           | OE = GND  | -   | 18.5                | -   | -                       | 30           | μΑ   |
|                     |                           | $\overline{OE} = V_{CC}$ (low-power mode)   | -   | 0.01                | -   | -                       | 2            | μΑ   |
| Δl <sub>CC</sub>    | additional supply current | S, $\overline{\text{OE}}$ input;<br>one input at 1.8 V;<br>other inputs at GND or V <sub>CC</sub> |     |                     |     |                         |              |      |
|                     |                           | V <sub>CC</sub> = 2.7 V   | -   | 0.8                 | -   | -                       | 1.8          | μΑ   |
|                     |                           | $V_{CC} = 3.6 \text{ V}$  | -   | 12.5                | -   | -                       | 20           | μΑ   |
| Cı                  | input<br>capacitance      | $V_{SW} = GND \text{ or } V_{CC};$<br>$V_{CC} = 2.5 \text{ V}, 3.3 \text{ V}$                     | -   | 1                   | -   | -                       | 2.5          | pF   |
| C <sub>S(OFF)</sub> | OFF-state capacitance     | $V_{SW} = GND \text{ or } V_{CC};$<br>$V_{CC} = 2.5 \text{ V}, 3.3 \text{ V}$                     | -   | 3                   | -   | -                       | 5.0          | pF   |
| C <sub>S(ON)</sub>  | ON-state capacitance      | $V_{SW}$ = GND or $V_{CC}$ ;<br>$V_{CC}$ = 2.5 V, 3.3 V   | -   | 6                   | -   | -                       | 7.5          | pF   |

### 11.1 Test circuits



### High-speed USB 2.0 switch with enable

#### 11.2 ON resistance

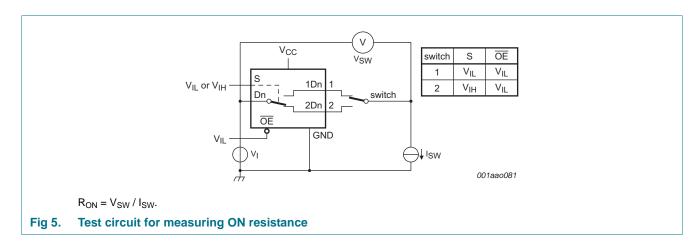
Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 6.

| Symbol                | Parameter                    | Conditions  | T <sub>amb</sub> = | = -40 °C to | +85 °C | $T_{amb} = -40$ | Unit |   |
|-----------------------|------------------------------|---|--------------------|-------------|--------|-----------------|------|---|
|                       |                              |   | Min                | Typ[1]      | Max    | Min             | Max  |   |
| R <sub>ON</sub>       | ON resistance                | $V_{CC} = 2.3 \text{ V}, 3.0 \text{ V}$<br>see Figure 5                   |                    |             |        |                 |      |   |
|                       |                              | $V_{I} = 0 V;$<br>$I_{I} = 30 \text{ mA}$                                 | -                  | 3.6         | -      | -               | 6    | Ω |
|                       |                              | $V_{I} = 2.4 \text{ V};$<br>$I_{I} = -15 \text{ mA}$                      | -                  | 4.3         | -      | -               | 7    | Ω |
| $\Delta R_{ON}$       | ON resistance                | $V_{CC} = 2.3 \text{ V}, 3.0 \text{ V}$                                   | <u>:]</u>          |             |        |                 |      |   |
|                       | mismatch<br>between channels | $V_{I} = 0 V;$<br>$I_{I} = 30 \text{ mA}$                                 | -                  | 0.1         | -      | -               | -    | Ω |
|                       |                              | $V_I = 1.7 \text{ V};$ $I_I = -15 \text{ mA}$                             | -                  | 0.1         | -      | -               | -    | Ω |
| R <sub>ON(flat)</sub> | ON resistance (flatness)     | $V_{CC} = 2.3 \text{ V}, 3.0 \text{ V};$ $V_{I} = 0 \text{ V to } V_{CC}$ | <u> </u>           |             |        |                 |      |   |
|                       |                              | $I_I = 30 \text{ mA}$   | -                  | 0.8         | -      | -               | -    | Ω |
|                       |                              | $I_I = -15 \text{ mA}$  | -                  | 0.7         | -      | -               | -    | Ω |

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

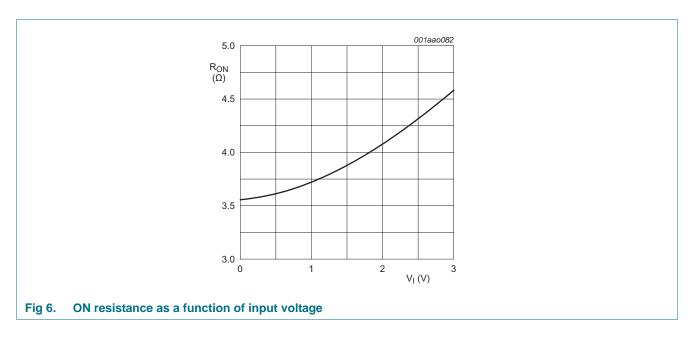
### 11.3 ON resistance test circuit and waveforms



<sup>[2]</sup> Measured at identical V<sub>CC</sub>, temperature and input voltage.

<sup>[3]</sup> Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

# High-speed USB 2.0 switch with enable



# 12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 10.

| Symbol           | Parameter         | Conditions                                 |        | T, | <sub>amb</sub> = 25 | °C  | $T_{amb} = -40^{\circ}$ | Unit |    |
|------------------|-------------------|--|--------|----|---------------------|-----|-------------------------|------|----|
|                  |                   |  |        |    | Typ[1]              | Max | Min                     | Max  |    |
| t <sub>pd</sub>  | propagation delay | Dn to nDn or nDn to Dn; see Figure 7       | [2][3] |    |                     |     |                         |      |    |
|                  |                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |        | -  | 0.25                | -   | -                       | -    | ns |
|                  |                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ |        | -  | 0.25                | -   | -                       | -    | ns |
| t <sub>en</sub>  | enable time       | S to Dn, nDn;<br>see Figure 9              | [3]    |    |                     |     |                         |      |    |
|                  |                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |        | -  | -                   | -   | -                       | 50   | ns |
|                  |                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ |        | -  | -                   | -   | -                       | 30   | ns |
|                  |                   | OE to Dn, nDn;<br>see Figure 9             | [3]    |    |                     |     |                         |      |    |
|                  |                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |        | -  | -                   | -   | -                       | 32   | ns |
|                  |                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ |        | -  | -                   | -   | -                       | 17   | ns |
| t <sub>dis</sub> | disable time      | S to Dn, nDn;<br>see Figure 9              | [3]    |    |                     |     |                         |      |    |
|                  |                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |        | -  | -                   | -   | -                       | 23   | ns |
|                  |                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ |        | -  | -                   | -   | -                       | 12   | ns |
|                  |                   | OE to Dn, nDn;<br>see Figure 9             | [3]    |    |                     |     |                         |      |    |
|                  |                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |        | -  | -                   | -   | -                       | 12   | ns |
|                  |                   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ |        | -  | -                   | -   | -                       | 10   | ns |

### High-speed USB 2.0 switch with enable

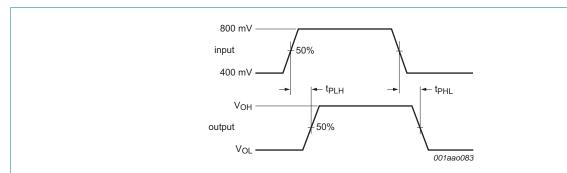
Table 9. Dynamic characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 10.

| Symbol             | Parameter        | Conditions                                 |    | Ta  | T <sub>amb</sub> = 25 °C |     | $T_{amb} = -40  ^{\circ}\text{C} \text{ to } +85  ^{\circ}\text{C}$ |     | Unit |
|--------------------|------------------|--|----|-----|--------------------------|-----|---|-----|------|
|                    |                  |  |    | Min | Typ[1]                   | Max | Min   | Max |      |
| $t_{sk(o)}$        | output skew time | see Figure 8                               | 4] |     |                          |     |   |     |      |
|                    |                  | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |    | -   | 0.1                      | -   | -   | 0.2 | ns   |
|                    |                  | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ |    | -   | 0.1                      | -   | -   | 0.2 | ns   |
| t <sub>sk(p)</sub> | pulse skew time  | see Figure 7                               | 4] |     |                          |     |   |     |      |
|                    |                  | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |    | -   | 0.1                      | -   | -   | 0.2 | ns   |
|                    |                  | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ |    | -   | 0.1                      | -   | -   | 0.2 | ns   |

- [1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 2.5 V and 3.3 V respectively.
- [2] The propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
- [3]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [4] Guaranteed by design.

# 12.1 Waveforms, test circuit and graphs



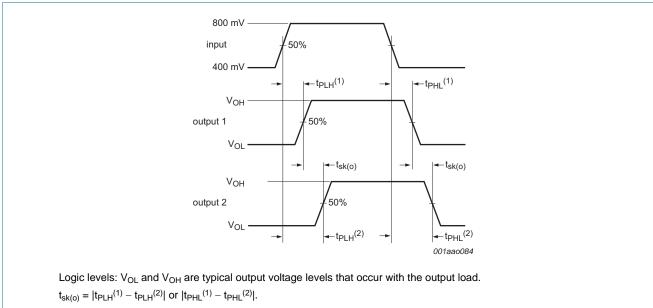
Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

 $t_{sk(p)} = |t_{PHL} - t_{PLH}|.$ 

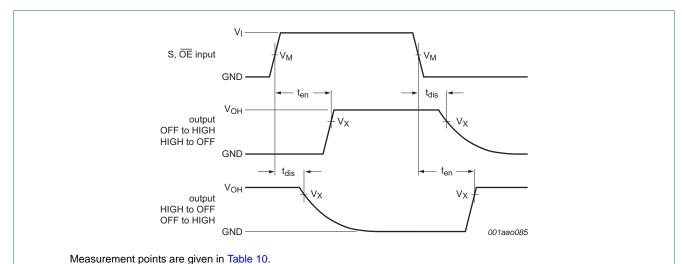
Fig 7. The data input to output propagation delay times and pulse skew time

**NX3DV221 NXP Semiconductors** 

### High-speed USB 2.0 switch with enable



**Output skew time** Fig 8.



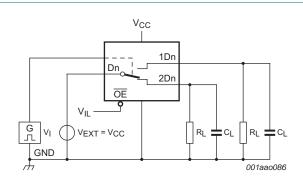
Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 9. **Enable and disable times** 

Table 10. **Measurement points** 

| Supply voltage  | Input             | Output         |                    |
|-----------------|-------------------|----------------|--------------------|
| V <sub>CC</sub> | V <sub>M</sub>    | V <sub>X</sub> |                    |
| 2.3 V to 3.6 V  | 0.5V <sub>I</sub> | 1. 8 V         | 0.9V <sub>OH</sub> |

### High-speed USB 2.0 switch with enable



Test data is given in Table 11.

Definitions test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $V_{EXT}$  = External voltage for measuring switching times.

 $V_I$  may be connected to S or  $\overline{OE}$ .

Fig 10. Test circuit for switching times

Table 11. Test data

| Supply voltage  | Input          |                                 | Load  |                |
|-----------------|----------------|---------------------------------|-------|----------------|
| V <sub>CC</sub> | V <sub>I</sub> | t <sub>r</sub> , t <sub>f</sub> | CL    | R <sub>L</sub> |
| 2.3 V to 3.6 V  | 1.8 V          | ≤ 5 ns                          | 50 pF | 500 Ω          |

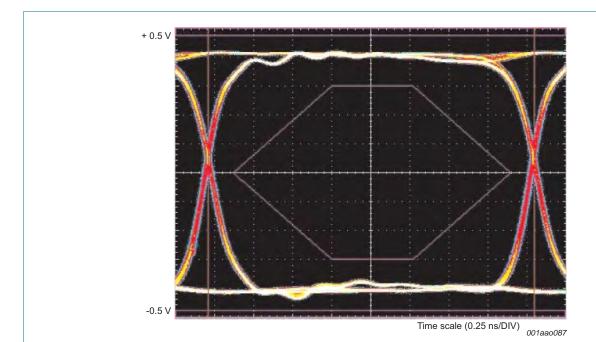
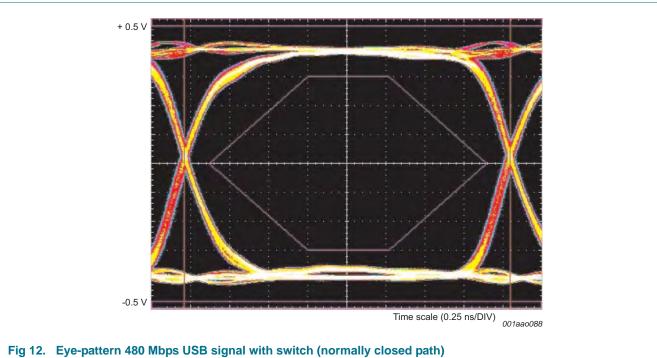


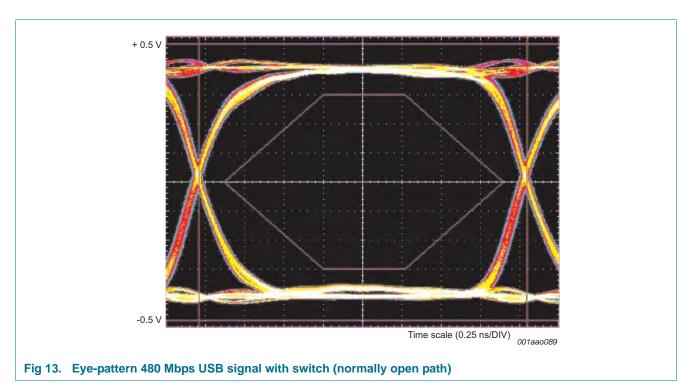
Fig 11. Eye-pattern 480 Mbps USB signal with no switch.

**NX3DV221 NXP Semiconductors** 

# High-speed USB 2.0 switch with enable







### High-speed USB 2.0 switch with enable

# 12.2 Additional dynamic characteristics

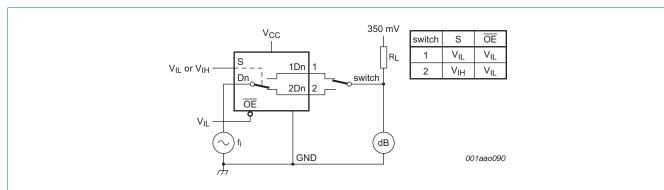
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_l = \text{GND}$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 5$  ns;  $T_{amb} = 25$  °C.

| Symbol                                       | Parameter  | Conditions   |        | Min | Тур | Max | Unit |
|--|--|--|--------|-----|-----|-----|------|
| f <sub>(-3dB)</sub> -3 dB frequency response | $R_L = 50 \Omega$ ; see Figure 14  | [1][2]   |        |     |     |     |      |
|  | V <sub>CC</sub> = 2.3 V to 2.7 V   |  | -      | 1.0 | -   | GHz |      |
|  | V <sub>CC</sub> = 3.0 V to 3.6 V   |  | -      | 1.0 | -   | GHz |      |
| $\alpha_{\text{iso}}$ isolation (OFF-state)  | isolation (OFF-state)  | $f_i$ = 250 MHz; $R_L$ = 50 $\Omega$ ; see Figure 15 | [1][2] |     |     |     |      |
|  | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$                                       |  | -      | -38 | -   | dB  |      |
|  | V <sub>CC</sub> = 3.0 V to 3.6 V   |  | -      | -38 | -   | dB  |      |
| Xtalk crosstalk                              | between switches;<br>$f_i = 250 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see Figure 16 | [1][2]   |        |     |     |     |      |
|  |  | V <sub>CC</sub> = 2.3 V to 2.7 V                     |        | -   | -40 | -   | dB   |
|  | V <sub>C</sub>   | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$           |        | -   | -40 | -   | dB   |

<sup>[1]</sup> f<sub>i</sub> is biased at 350 mV.

### 12.3 Test circuits

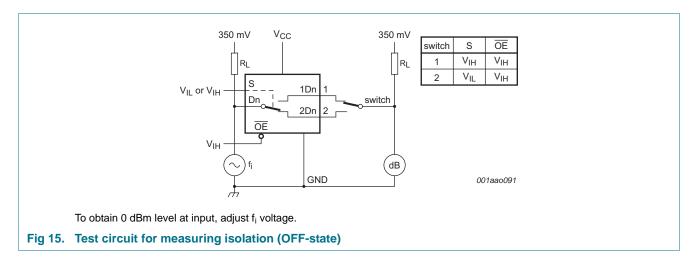


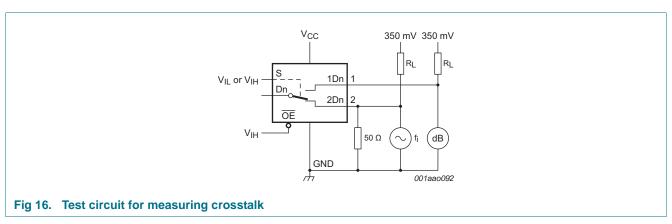
To obtain 0 dBm level at output, adjust fi voltage. Increase fi frequency until dB meter reads -3 dB.

Fig 14. Test circuit for measuring the frequency response when switch is in ON-state

<sup>[2]</sup>  $V_i = 632 \text{ mV (p-p)}$ 

# High-speed USB 2.0 switch with enable





### High-speed USB 2.0 switch with enable

# 13. Package outline

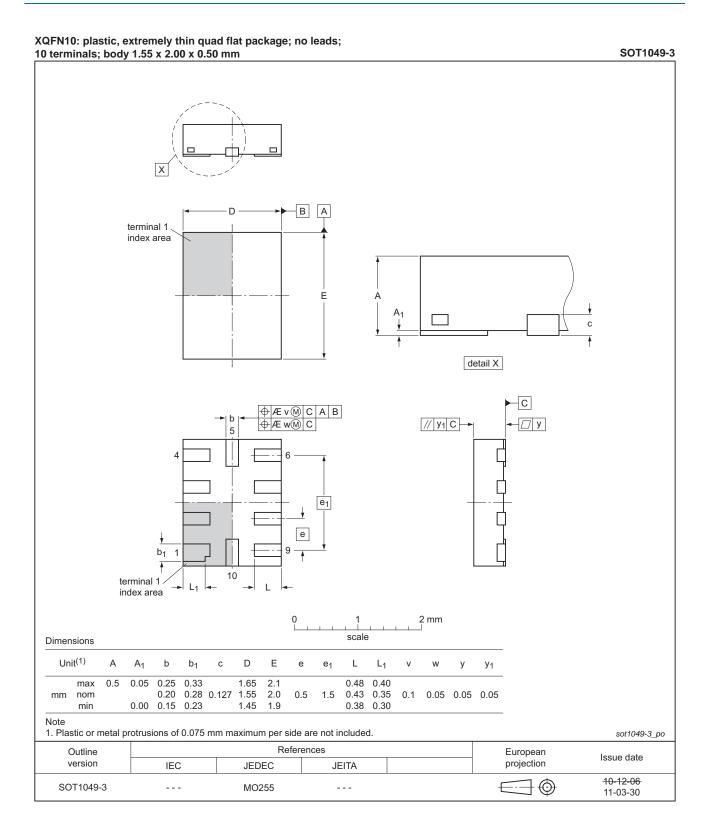


Fig 17. Package outline SOT1049-3 (XQFN10)

(3DV221 All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2013. All rights reserved.

### High-speed USB 2.0 switch with enable

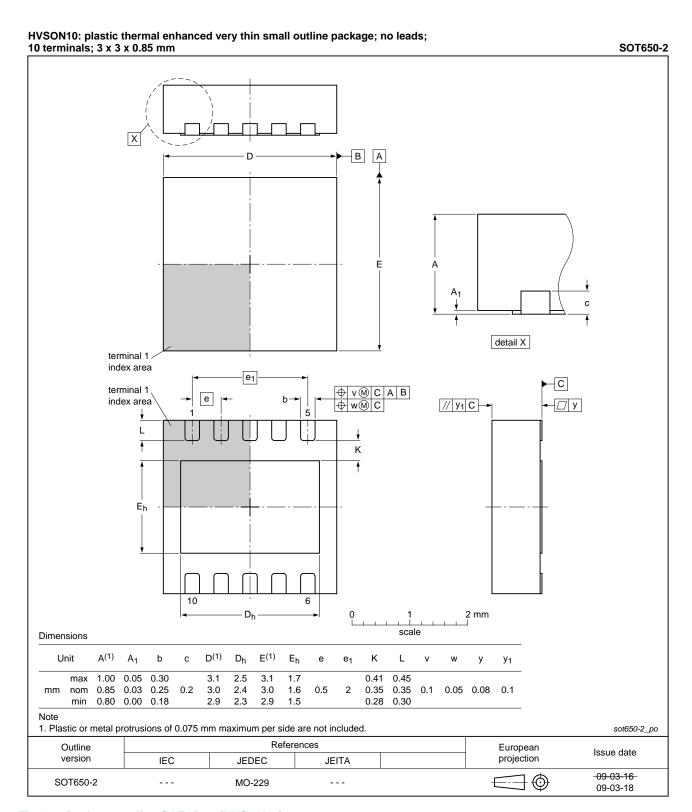


Fig 18. Package outline SOT650-2 (HVSON10)

NX3DV221 All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2013. All rights reserved.

# High-speed USB 2.0 switch with enable

# 14. Abbreviations

#### Table 13. Abbreviations

| Acronym | Description                             |
|---------|---|
| CDM     | Charged Device Model                    |
| CMOS    | Complementary Metal Oxide Semiconductor |
| ESD     | ElectroStatic Discharge                 |
| НВМ     | Human Body Model                        |
| MM      | Machine Model                           |

# 15. Revision history

### Table 14. Revision history

| Document ID    | Release date                    | Data sheet status                   | Change notice  | Supersedes   |
|----------------|---------------------------------|-------------------------------------|----------------|--------------|
| NX3DV221 v.4   | 20130619                        | Product data sheet                  | -              | NX3DV221 v.3 |
| Modifications: | <ul> <li>Type number</li> </ul> | er NX3DV221TK added.                |                |              |
|                | <ul> <li>Package ou</li> </ul>  | tline drawing added ( <u>Figure</u> | <u>e 18</u> ). |              |
| NX3DV221 v.3   | 20120705                        | Product data sheet                  | -              | NX3DV221 v.2 |
| NX3DV221 v.2   | 20111109                        | Product data sheet                  | -              | NX3DV221 v.1 |
| NX3DV221 v.1   | 20110421                        | Product data sheet                  | -              | -            |

#### High-speed USB 2.0 switch with enable

# 16. Legal information

#### 16.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 16.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

NX3DV221

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2013. All rights reserved.

### High-speed USB 2.0 switch with enable

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

#### 16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

### 17. Contact information

For more information, please visit: <a href="http://www.nxp.com">http://www.nxp.com</a>

For sales office addresses, please send an email to: salesaddresses@nxp.com

**NX3DV221 NXP Semiconductors** 

# High-speed USB 2.0 switch with enable

# 18. Contents

| 1    | General description                      | 1  |
|------|--|----|
| 2    | Features and benefits                    | 1  |
| 3    | Applications                             | 1  |
| 4    | Ordering information                     |    |
| 5    | Marking                                  | 2  |
| 6    | Functional diagram                       |    |
| 7    | Pinning information                      | 3  |
| 7.1  | Pinning                                  | 3  |
| 7.2  | Pin description                          |    |
| 8    | Functional description                   | 3  |
| 9    | Limiting values                          | 4  |
| 10   | Recommended operating conditions         | 4  |
| 11   | Static characteristics                   | 4  |
| 11.1 | Test circuits                            | 5  |
| 11.2 | ON resistance                            | _  |
| 11.3 | ON resistance test circuit and waveforms | 6  |
| 12   | Dynamic characteristics                  | 7  |
| 12.1 | Waveforms, test circuit and graphs       |    |
| 12.2 | Additional dynamic characteristics       |    |
| 12.3 | Test circuits                            | 12 |
| 13   | Package outline                          | 14 |
| 14   | Abbreviations                            | 16 |
| 15   | Revision history                         | 16 |
| 16   | Legal information 1                      | 17 |
| 16.1 | Data sheet status                        | 17 |
| 16.2 | Definitions                              | 17 |
| 16.3 |  | 17 |
| 16.4 | Trademarks                               | 18 |
| 17   | Contact information                      | 18 |
| 18   | Contents                                 | 19 |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for USB Switch ICs category:

Click to view products by NXP manufacturer:

Other Similar products are found below:

NLAS7213MUTBG FSA221UMX FSUSB31UMX FSA806UMX NLAS7222AMTR2G NL3S2223MUTBG TC7USB3212WBG(ELAH PI3USB31531ZLCEX PI3USB31532ZLCEX PI5USB31213XEAEX BD91N01NUX-E2 MP5030DGQH-Z NL3S22AHMUTAG NL3S22UHMUTAG FSA9280AUMX NLAS7242MUTBG HD3SS460RHRT TPS2549IRTERQ1 PI2USB4122ZHEX TS5USBC402IYFPT NS5S1153MUTAG FSUSB11MTCX FSUSB42MUX FT234XD-R PI3USB102GZLEX P6KE110A SMAJ200A SMAJ70CA SMAJ11A SMAJ140CA SMAJ14A SMAJ160CA SMAJ250A SMAJ51CA SMAJ5.0CA 30KP400CA 1SMB5.0AT3G MAX4717ETB+T MAX4989ETD+T MAX4717EBCT MAX4717EUB+ MAX4906ELB+T MAX4899EETE+ MAX4906EFELB+T MAX4907FELA+T MAX4907ELA+T MAX4983EEVB+T MAX4984EEVB+T MAX4899AEETE+T MAX14618ETA+T